



# RoHS and Lead-Free Certification

## for All Enova Technology X-Wall ASICs

All X-Wall ASICs designed and manufactured by Enova Technology are RoHS and Lead-Free compliant. All compliant X-Wall parts are designated with a letter "U". More, the substances restricted by RoHS directive are not intentionally added and do not exceed RoHS maximum concentration values in any homogeneous material. Enova Technology X-Wall ASICs do not contain other banned substances listed below and are not manufactured with ozone depleting substances subject to the Montreal Protocol.

Persuade to 94/62/EEC, packing materials (Carton, Tray, ESD vacuum bag, Silica gel, Antistatic bubble bag, Moisture indicator, Ribbon etc.) contain less than a summed total concentration of 100 ppm of lead, mercury, hexavalent chromium and cadmium.

### Banned Substances

- Cadmium and cadmium compounds
- Hexavalent chromium compounds
- Lead and lead compounds
- Mercury and mercury compounds
- Asbestos
- Azo compounds
- Formaldehyde
- Polybrominated biphenyls (PBBs) and diphenyl ethers (PBDEs)
- Polychlorinated biphenyls (PCBs), terphenyls(PCT), PVC and naphthalenes
- Short chain chlorinated paraffins(C10~C13)
- Tributyltin(TBT), triphenyltin(TPT)
- Ozone depleting substances
- Radioactive substances

Signature : 

Name/Title : President & CEO

Date : 4/12/2006



### Enova Technology Corporation

1st Floor, #11, Research & Development 2<sup>nd</sup> Road, Science  
-based Industrial Park, Hsin-Chu City Taiwan 300, Republic of China

TEL: +886 (3) 577-2767 FAX: +886 (3) 577-2770 www.enovatech.com